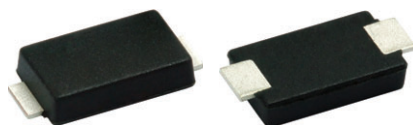


## Surface-Mount ESD Capability Rectifiers

### eSMP® Series



Top View

Bottom View

### SlimSMA (DO-221AC)

Cathode  Anode

### FEATURES

- Very low profile - typical height of 0.95 mm
- Ideal for automated placement
- Oxide planar chip junction
- Low forward voltage drop, low leakage current
- ESD capability
- Meets MSL level 1, per J-STD-020, LF maximum peak of 260 °C
- AEC-Q101 qualified
- Material categorization: for definitions of compliance please see [www.vishay.com/doc?99912](http://www.vishay.com/doc?99912)


**RoHS**  
COMPLIANT  
HALOGEN  
**FREE**

### LINKS TO ADDITIONAL RESOURCES



| PRIMARY CHARACTERISTICS                  |                            |
|------------------------------------------|----------------------------|
| $I_{F(AV)}$                              | 2.0 A                      |
| $V_{RRM}$                                | 100 V, 200 V, 400 V, 600 V |
| $I_{FSM}$                                | 35 A                       |
| $V_F$ at $I_F = 2.0$ A ( $T_A = 125$ °C) | 0.86 V                     |
| $I_R$                                    | 5 $\mu$ A                  |
| $T_J$ max.                               | 175 °C                     |
| Package                                  | SlimSMA (DO-221AC)         |
| Circuit configuration                    | Single                     |

### TYPICAL APPLICATIONS

General purpose, power line polarity protection, in both consumer and automotive applications.

### MECHANICAL DATA

**Case:** SlimSMA (DO-221AC)

Molding compound meets UL 94 V-0 flammability rating  
Base P/N-M3 - halogen-free, RoHS-compliant, and commercial grade

Base P/NHM3 - halogen-free, RoHS-compliant, and AEC-Q101 qualified

**Terminals:** matte tin plated leads, solderable per J-STD-002 and JESD 22-B102

M3 suffix meets JESD 201 class 1A whisker test, HM3 suffix meets JESD 201 class 2 whisker test

**Polarity:** color band denotes the cathode end

| MAXIMUM RATINGS (T <sub>A</sub> = 25 °C unless otherwise noted)                   |                                   |             |         |         |         |      |
|-----------------------------------------------------------------------------------|-----------------------------------|-------------|---------|---------|---------|------|
| PARAMETER                                                                         | SYMBOL                            | SE20AFB     | SE20AFD | SE20AFG | SE20AFJ | UNIT |
| Device marking code                                                               |                                   | S2B         | S2D     | S2G     | S2J     |      |
| Maximum repetitive peak reverse voltage                                           | V <sub>RRM</sub>                  | 100         | 200     | 400     | 600     | V    |
| Maximum DC forward current                                                        | I <sub>F</sub> <sup>(1)</sup>     | 2.0         |         |         |         | A    |
|                                                                                   | I <sub>F</sub> <sup>(2)</sup>     | 1.3         |         |         |         |      |
| Peak forward surge current 10 ms single half sine-wave superimposed on rated load | I <sub>FSM</sub>                  | 35          |         |         |         | A    |
| Operating junction and storage temperature range                                  | T <sub>J</sub> , T <sub>STG</sub> | -55 to +175 |         |         |         | °C   |

### Notes

(1) Mounted on 5.0 mm x 5.0 mm pad areas, 2 oz. FR4 PCB

(2) Free air, mounted on recommended copper pad area

**ELECTRICAL CHARACTERISTICS** ( $T_A = 25\text{ }^{\circ}\text{C}$  unless otherwise noted)

| PARAMETER                     | TEST CONDITIONS                                                          |                         | SYMBOL                        | TYP. | MAX. | UNIT |
|-------------------------------|--------------------------------------------------------------------------|-------------------------|-------------------------------|------|------|------|
| Instantaneous forward voltage | I <sub>F</sub> = 1.0 A                                                   | T <sub>A</sub> = 25 °C  | V <sub>F</sub> <sup>(1)</sup> | 0.91 | -    | V    |
|                               | I <sub>F</sub> = 2.0 A                                                   |                         |                               | 0.96 | 1.1  |      |
|                               | I <sub>F</sub> = 1.0 A                                                   | T <sub>A</sub> = 125 °C |                               | 0.79 | -    |      |
|                               | I <sub>F</sub> = 2.0 A                                                   |                         |                               | 0.86 | 0.98 |      |
| Reverse current               | Rated V <sub>R</sub>                                                     | T <sub>A</sub> = 25 °C  | I <sub>R</sub> <sup>(2)</sup> | -    | 5.0  | μA   |
|                               |                                                                          | T <sub>A</sub> = 125 °C |                               | 8    | 100  |      |
| Typical reverse recovery time | I <sub>F</sub> = 0.5 A, I <sub>R</sub> = 1.0 A, I <sub>rr</sub> = 0.25 A |                         | t <sub>rr</sub>               | 1.2  | -    | μs   |
| Typical junction capacitance  | 4.0 V, 1 MHz                                                             |                         | C <sub>J</sub>                | 12   | -    | pF   |

**Notes**(1) Pulse test: 300  $\mu\text{s}$  pulse width, 1 % duty cycle(2) Pulse test: Pulse width  $\leq 40\text{ ms}$ **THERMAL CHARACTERISTICS** ( $T_A = 25\text{ }^{\circ}\text{C}$  unless otherwise noted)

| PARAMETER                  | SYMBOL                | SE20AFB | SE20AFD | SE20AFG | SE20AFJ | UNIT |
|----------------------------|-----------------------|---------|---------|---------|---------|------|
| Typical thermal resistance | $R_{\theta JA}^{(1)}$ | 125     |         |         |         | °C/W |
|                            | $R_{\theta JM}^{(2)}$ | 12      |         |         |         |      |

**Notes**(1) Free air, mounted on recommended PCB, 1 oz. pad area; thermal resistance  $R_{\theta JA}$  - junction to ambient(2) Mounted on 5.0 mm x 5.0 mm pad areas, 2 oz. FR4 PCB;  $R_{\theta JM}$  - junction to mount**IMMUNITY TO ELECTRICAL STATIC DISCHARGE TO THE FOLLOWING STANDARDS**( $T_A = 25\text{ }^{\circ}\text{C}$  unless otherwise noted)

| STANDARD     | TEST TYPE                       | TEST CONDITIONS                                | SYMBOL | CLASS | VALUE           |
|--------------|---------------------------------|------------------------------------------------|--------|-------|-----------------|
| AEC-Q101-001 | Human body model (contact mode) | $C = 100\text{ pF}$ , $R = 1.5\text{ k}\Omega$ | $V_C$  | H3B   | $> 8\text{ kV}$ |

**ORDERING INFORMATION** (Example)

| PREFERRED P/N                | UNIT WEIGHT (g) | PREFERRED PACKAGE CODE | BASE QUANTITY | DELIVERY MODE                      |
|------------------------------|-----------------|------------------------|---------------|------------------------------------|
| SE20AFJ-M3/6A                | 0.032           | 6A                     | 3500          | 7" diameter plastic tape and reel  |
| SE20AFJ-M3/6B                | 0.032           | 6B                     | 14 000        | 13" diameter plastic tape and reel |
| SE20AFJHM3/6A <sup>(1)</sup> | 0.032           | 6A                     | 3500          | 7" diameter plastic tape and reel  |
| SE20AFJHM3/6B <sup>(1)</sup> | 0.032           | 6B                     | 14 000        | 13" diameter plastic tape and reel |

**Note**

(1) AEC-Q101 qualified



**RATINGS AND CHARACTERISTICS CURVES** ( $T_A = 25^\circ\text{C}$  unless otherwise noted)

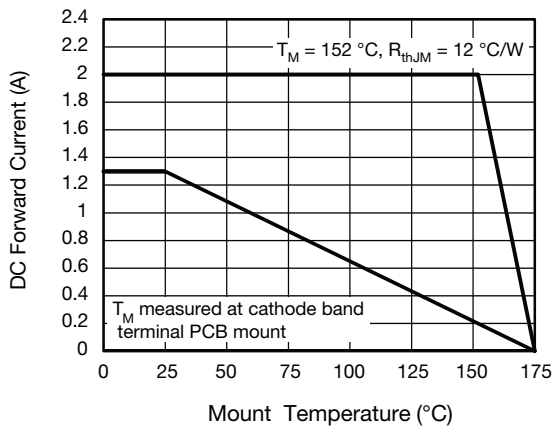


Fig. 1 - Maximum Forward Current Derating Curve

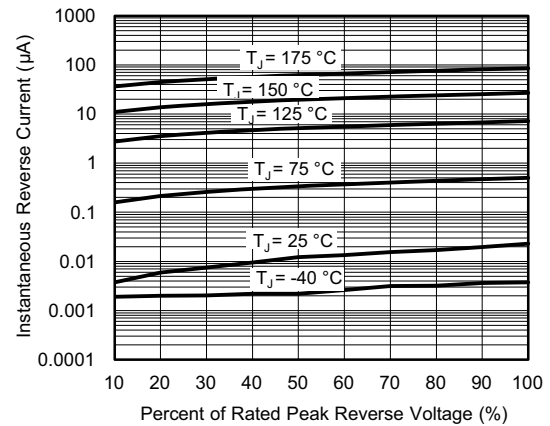


Fig. 4 - Typical Reverse Leakage Characteristics

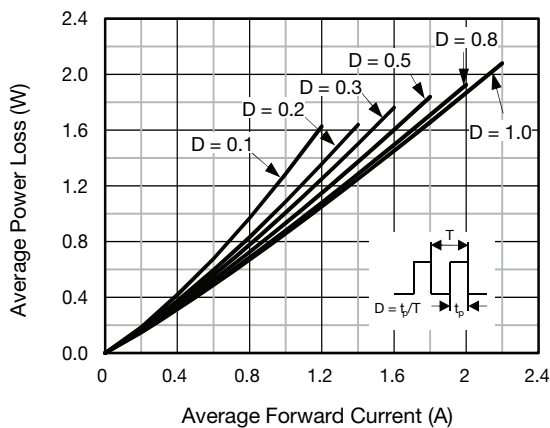


Fig. 2 - Forward Power Loss Characteristics

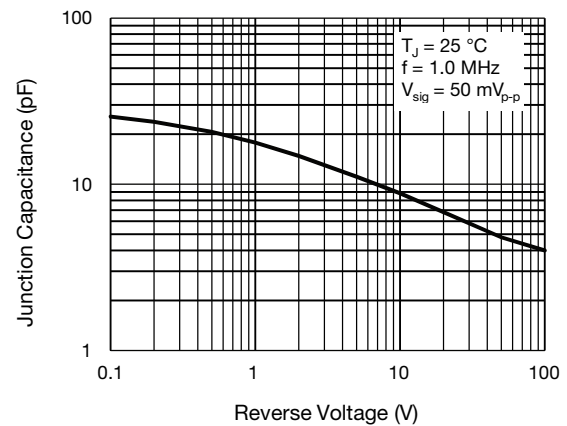


Fig. 5 - Typical Junction Capacitance

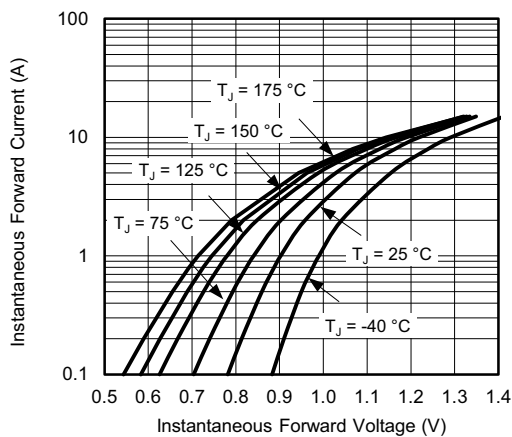


Fig. 3 - Typical Instantaneous Forward Characteristics

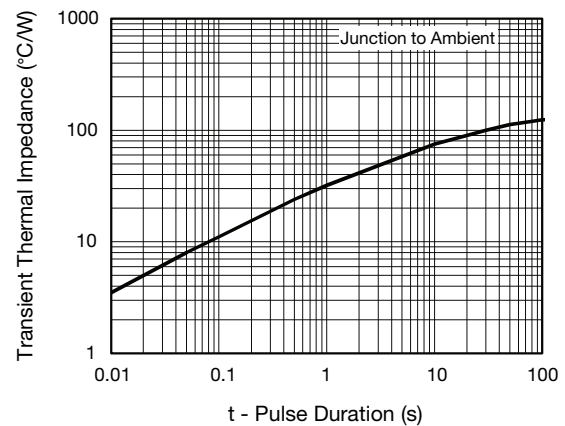


Fig. 6 - Typical Junction Capacitance

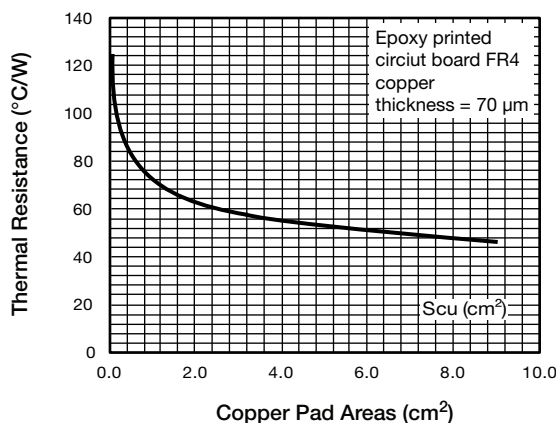
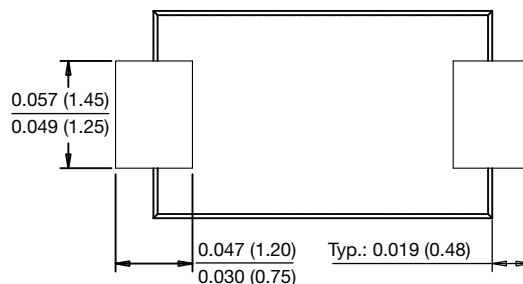
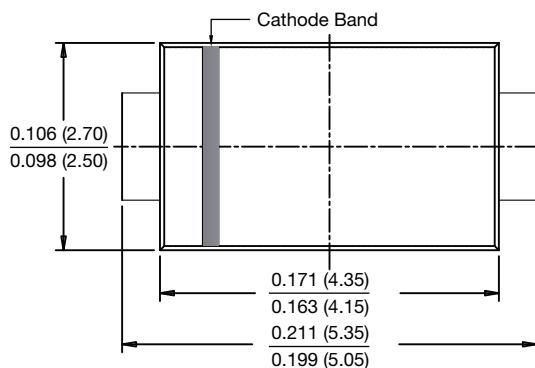


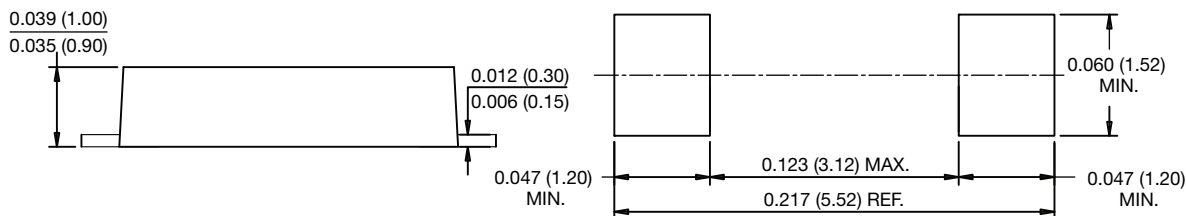
Fig. 7 - Thermal Resistance Junction to Ambient vs. Copper Pad Areas

# **PACKAGE OUTLINE DIMENSIONS** in inches (millimeters)

## **SlimSMA (DO-221AC)**



## **Mounting Pad Layout**





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